

# Two Remote Temperature Sensors and One Fan Controller with SMBus Serial Interface and System Reset Circuit

#### **Features**

- Measures Two Remote Temperatures
- No Calibration Required
- **SMBus 2-Wire Serial Interface**
- Programmable Under/Over-temperature Alarms
- Programmable Thermal Shutdown Signal
- Supports SMBus Alert Response
- Accuracy: ±5°C (-40°C to + 125°C, remote) ±3°C (+60°C to + 100°C, remote)
- +4.5V to +5.5V Supply Range
- Fan speed control range: 3,000 to 30,000 rpm
- Fan speed accuracy: ±2%
- Built-in MOSFET switch
- Internal current-limit and over-temperature protection for fan control
- Watchdog for fan control
- Alarm for fan failure
- Precision Monitoring of 5V Power-Supply
- 340ms Typical Power-On Reset Pulse Width **RESET Output**
- Guaranteed RESET Valid to V<sub>cc</sub>=1V
- Power Supply Transient Immunity
- No External Components needed for reset
- Small, 16-Pin SSOP Package

### **Applications**

- Desktop and Notebook
- **■** Central Office Computers
- Telecom Equipment
- Smart Battery Packs
- Test and Measurement
- LAN Servers

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- Multi-Chip Modules
- Industrial Controls

## **General Description**

The G768D contains a precise digital thermometer, a fan controller, and a system-reset circuit.

Except for one less fan controller, G768D is backward compatible with G768B. G768D has 2 more functions. fan-failure detection and programmable thermal shutdown signal.

The thermometer reports the temperature of 2 remote sensors. The remote sensors are diode-connected transistors typically a low-cost, easily mounted 2N3904 NPN type that replace conventional thermistors or thermocouples. Remote accuracy is ±5°C for multiple transistor manufacturers, with no calibration needed. The remote channel can also measure the die temperature of other ICs, such as microprocessors, that contain an on-chip, diode-connected transistor.

The 2-wire serial interface accepts standard System Management Bus (SMBus<sup>TM</sup>) Write Byte, Read Byte, Send Byte, and Receive Byte commands to program the alarm thresholds and to read temperature data. The data format is 7 bits plus sign, with each bit corresponding to 1°C, in two's-complement format. Measurements can be done automatically and autonomously, with the conversion rate programmed by the user or programmed to operate in a single-shot mode. The adjustable rate allows the user to control the supply-current drain.

G768D also contains a fan speed controller. It connects directly to the fans and performs closed-loop control of the fan speed independently. The only external component required is a 10µF capacitor per channel. It determines the current fan speed based on the fan rotation pulses and an externally supplied 32.768KHz clock.

# **Pin Configuration**



## **Ordering Information**

| PART NUMBER | TEMP. RANGE     | PIN-PACKAGE |  |
|-------------|-----------------|-------------|--|
| G768D       | -55°C to +125°C | 16SSOP      |  |

TEL: 886-3-5788833 http://www.gmt.com.tw

It uses LDO method and an on-chip MOSFET to control the fan speed to ±2% of the programmed speed.

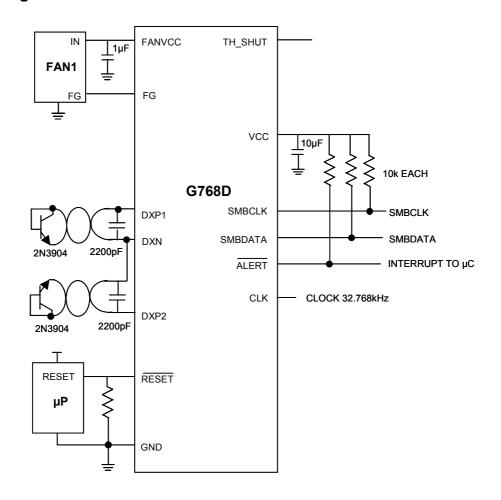
The desired fan speed is also programmed via SMBus<sup>TM</sup>. The actual fan speed and fan status can be read via the SMBus<sup>TM</sup>. Short-circuit protection is implemented to prevent damages to the fan and this IC itself. The accepted frequency of fan rotation pulses is 100~1000Hz, which corresponds to 3,000 to 30,000 rpm for a typical fan that produces two pulses per revolution. The G768D also turns on the fans by hardware watchdog system. The fan controller would fully turn on the fan when any of the following conditions happens.

- 1.when either of the remote temperature is higher than its own  $T_{\text{MAX}}$ .
- 2.when either of these two remote diodes is open.
- 3.when both remote diodes are short.

The G768D also contains a microprocessor ( $\mu P$ ) supervisory circuit used to monitor the power supplies in  $\mu P$  and digital systems. They provide excellent circuit reliability and low cost by eliminating external components and adjustments when used with 5V-powered circuits. This circuit asserts a reset signal whenever the  $V_{CC}$  supply voltage declines below a preset threshold, keeping it asserted for at least 140ms after  $V_{CC}$  has risen above the reset threshold. The G768D has an active-low  $\overline{RESET}$  output. The reset comparator is designed to ignore fast transients on  $V_{CC}$ . Reset threshold of this circuit is set to 4.4V typical.

The G768D is available in a small, 16-pin SSOP surface-mount package.

## **Typical Operating Circuit**





G768D

# **Absolute Maximum Ratings**

| V <sub>CC</sub> to GND0.3V to +6\          |
|--|
| DXP1, DXP2 to GND0.3V to $(V_{CC} + 0.3V)$ |
| DXN to GND0.3V to +0.8\                    |
| CLK, FG, SMBCLK, SMBDATA, ALERT to         |
| GND0.3V to +6\                             |
| SMBDATA, ALERT Current1mA to +50mA         |
| DXN Current±1mA                            |
| ESD Protection (SMBCLK SMBDATA ALERT hu-   |

| man body model)                                      | 2000V  |
|--|--------|
| ESD Protection (other pins, human body model)        | 2000V  |
| Continuous Power Dissipation (T <sub>A</sub> = +70°C | ) SSOP |
| (de-rate 8.30mW/°C above +70°C)                      | .667mW |
| Operating Temperature Range55°C to                   | +125°C |
| Junction Temperature                                 | +150°C |
| Storage temperature Range65°C to                     | +165°C |
| Lead Temperature (soldering, 10sec)                  | +300°C |
|  |        |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **Electrical Characteristics**

( $V_{CC}$  = + 5V,  $T_A$  = 60°C, unless otherwise noted.)

| PARAMETER   | CONDITIONS  |   |     | TYP    | MAX  | UNITS |
|---|---|---|-----|--------|------|-------|
| Temperature Sensor                                |   |   |     |        |      |       |
| Temperature Resolution (Note 1)                   | Monotonicity guaranteed   |   | 8   |        |      | Bits  |
| Temperature Error, Remote Diode (Notes 2          | T <sub>R</sub> = 0°C to +125°C                                    |   | -5  |        | 5    | °C    |
| and 3)  | T <sub>R</sub> = 60°C to +100°C                                   |   |     |        |      | C     |
| Temperature Error, Local Diode<br>(Notes 1 and 2) | Including long-term drift   | T <sub>A</sub> = +60°C to +100°C              | -3  |        | 3    | °C    |
| Supply-Voltage Range                              |   |   | 4.5 | 5      | 5.5  | V     |
| Under-voltage Lockout Threshold                   | V <sub>CC</sub> input, disables A/D conve                         | 2.6   | 2.8 | 2.95   | V    |       |
| Under-voltage Lockout Hysteresis                  |   |   |     | 50     |      | mV    |
| Power-On Reset Threshold                          | V <sub>CC</sub> , falling edge                                    | 1.0   | 1.7 | 2.5    | V    |       |
| POR Threshold Hysteresis                          |   |   |     | 50     |      | mV    |
|   | Logic inputs forced to V <sub>CC</sub> or                         | SMBus static                                  |     | 3      | 10   |       |
| Standby Supply Current                            | GND   | Hardware or software standby, SMBCLK at 10kHz |     | 200    |      | μA    |
|   | Auto-convert mode, average  | 0.25 conv/sec                                 |     | 250    | 300  |       |
| Average Operating Supply Current                  | measured over 4sec. Logic inputs forced to V <sub>CC</sub> or GND | 2.0 conv/sec                                  |     | 300    | 350  | μΑ    |
| Conversion Time                                   | From stop bit to conversion c                                     | 94  | 125 | 156    | ms   |       |
| Conversion Rate Timing Error                      | Auto-convert mode   | -25   |     | 25     | %    |       |
| Daniela Biada Canasa Canasa                       |   | High level                                    | 120 | 160    | 200  |       |
| Remote-Diode Source Current                       | DXP forced to 1.5V  | Low level                                     | 15  | 20     | 25   | μA    |
| Fan Controller                                    |   |   |     |        |      |       |
| Supply voltage                                    | V <sub>C</sub>  | cc  | 4.5 | 5      | 5.5  | V     |
| Shutdown current                                  | Fan spee  | d = 0rpm                                      |     | 2      | 5    | μA    |
| MOSFET on resistance                              |   |   |     | 0.2    | 0.25 | Ω     |
| Short-circuit current limit                       |   |   |     | 0.5    |      | Α     |
| Input logic low                                   | VI  | L   |     |        | 0.7. | V     |
| Input logic high                                  | VI  | Н   | 1.0 |        |      | V     |
| Clock frequency                                   | CLK   |   |     | 32.768 | 3    | KHz   |
| FANVCC over-current trig                          |   |   | 600 |        |      | mA    |
| FANVCC current limit                              |   |   | 500 |        |      | mA    |
| FG input Positive-going threshold voltage         | V <sub>CC</sub> =   |   | 1   |        | V    |       |
| FG input Negative-going threshold voltage         | V <sub>CC</sub> =   | =5V   |     | 0.7    |      | V     |
| FG input Hysteresis voltage                       | V <sub>CC</sub> =   |   |     | 0.3    |      | V     |



**G768D** 

#### **Electrical Characteristics** (continued)

 $(V_{CC} = + 5V, T_A = 60^{\circ}C, unless otherwise noted.)$ 

| PARAMETER                          | CONDITIONS  | MIN | TYP | MAX | UNITS |
|------------------------------------|---|-----|-----|-----|-------|
| SMBus Interface                    |   |     |     |     |       |
| Logic Input High Voltage           | SMBCLK, SMBDATA; V <sub>CC</sub> = 4.5V to 5.5V         | 2.4 |     |     | V     |
| Logic Input Low Voltage            | SMBCLK, SMBDATA; V <sub>CC</sub> = 4.5V to 5.5V         |     |     | 8.0 | V     |
| Logic Output Low Sink Current      | ALERT , SMBDATA forced to 0.4V                          | 6   |     |     | mA    |
| ALERT Output High Leakage Current  | ALERT forced to 5.5V                                    |     |     | 1   | μΑ    |
| Logic Input Current                | Logic inputs forced to V <sub>CC</sub> or GND           | -2  |     | 2   | μA    |
| SMBus Input Capacitance            | SMBCLK, SMBDATA   |     | 5   |     | pF    |
| SMBus Clock Frequency              | (Note 4)  | DC  |     | 100 | KHz   |
| SMBCLK Clock Low Time              | t <sub>LOW</sub> , 10% to 10% points                    | 4.7 |     |     | μs    |
| SMBCLK Clock High Time             | t <sub>HIGH</sub> , 90% to 90% points                   | 4   |     |     | μs    |
| SMBus Start-Condition Setup Time   |   | 4.7 |     |     | μs    |
| SMBus Repeated Start-Condition     | t <sub>SU: STA</sub> , 90% to 90% points                | 500 |     |     | ns    |
| Setup Time                         |   |     |     |     |       |
| SMBus Start-Condition Hold Time    | t <sub>HD: STA</sub> , 10% of SMBDATA to 90% of SMBCLK  | 4   |     |     | μs    |
| SMBus Start-Condition Setup Time   | t <sub>SD: STO</sub> , 90% of SMBDATA to 10% of SMBDATA | 4   |     |     | μs    |
| SMBus Data Valid to SMBCLK Rising- | t <sub>SU: DAT</sub> , 10% or 90% of SMBDATA to 10% of  | 800 |     |     | ns    |
| Edge Time                          | SMBCLK  |     |     |     |       |
| SMBus Data-Hold Time               | t <sub>HD:DAT</sub> (Note 5)                            | 0   |     |     | μs    |
| SMBCLK Falling Edge to SMBus       | Master clocking in data                                 |     |     | 1   | μs    |
| Data-Valid Time                    |   |     |     |     |       |

### **Electrical Characteristics** (continued)

(V<sub>CC</sub> =full range, T<sub>A</sub>= 60°C, unless otherwise noted.)

| PARAMETER                   | SYMBOL          | CONDITIONS   | MIN                  | TYP | MAX | UNITS |
|-----------------------------|-----------------|--|----------------------|-----|-----|-------|
| Reset Threshold             | $V_{TH}$        |  | 4.2                  | 4.4 | 4.5 | V     |
| Reset Active Timeout Period |                 |  |                      | 340 |     | ms    |
| RESET Output Voltage Low    | V <sub>OL</sub> | V <sub>CC</sub> =V <sub>TH</sub> min, I <sub>SINK</sub> =3.2mA   |                      |     | 0.4 | V     |
| RESET Output Voltage High   | V <sub>OH</sub> | V <sub>CC</sub> >V <sub>TH</sub> max, I <sub>SOURCE</sub> =5.0mA | V <sub>CC</sub> -1.5 |     |     | V     |

- Note 1: Guaranteed but not 100% tested.
- Note 2: Quantization error is not included in specifications for temperature accuracy. For example, if the G768D device temperature is exactly +66.7°C, or +68°C (due to the quantization error plus the +1/2°C offset used for rounding up) and still be within the guaranteed ±3°C error limits for the +60°C to +100°C temperature range. See Table3.
- Note 3: A remote diode is any diode-connected transistor from Table1. T<sub>R</sub> is the junction temperature of the remote diode. See Remote Diode Selection for remote diode forward voltage requirements.
- Note 4: The SMBus logic block is a static design that works with clock frequencies down to DC. While slow operation is possible, it violates the 10kHz minimum clock frequency and SMBus specifications, and may monopolize the bus.
- Note 5: Note that a transition must internally provide at least a hold time in order to bridge the undefined region (300ns max) of SMBCLK's falling edge.



### **Pin Description**

| PIN  | NAME            | FUNCTION  |
|------|-----------------|---|
| 1    | FANVCC          | Output connected to V <sub>CC</sub> of fan.   |
| 2,15 | V <sub>CC</sub> | Supply Voltage Input, 4.5V to 5.5V. Bypass to GND with a 0.1µF capacitor.   |
| 3    | DXP1            | Combined Current Source and A/D Positive Input for remote-diode channel 1. Do not leave DXP1 floating; tie DXP1 to DXN if no remote diode on channel 1 is used. Place a 2200pF capacitor between DXP1 and DXN for noise filtering.  |
| 4    | DXN             | Combined Current Sink and A/D Negative Input. DXN is common negative node of both remote diodes on channel 1 and 2. The traces of DXP1-DXN and DXP2-DXN pairs should be routed independently. The common DXN should be connected together as close as possible to the IC. DXN is internally connected to the GND pin for signal ground use. |
| 5    | DXP2            | Combined Current Source and A/D Positive Input for remote-diode channel 2. Do not leave DXP2 floating; tie DXP2 to DXN if no remote diode on channel 2 is used. Place a 2200pF capacitor between DXP2 and DXN for noise filtering.  |
| 6    | RESET           | $\overline{\text{RESET}}$ Output remains low while $V_{CC}$ is below the reset threshold, and for 340ms after $V_{CC}$ rises above the reset threshold.   |
| 7    | DGND            | Digital Ground.   |
| 8    | AGND            | Analog Ground.  |
| 9    | CLK             | 32.768KHz clock input for fan controller.   |
| 10   | FG              | Fan pulse input.  |
| 11   | ALERT           | SMBus Alert (interrupt) Output, open drain.   |
| 12   | SMBDATA         | SMBus Serial-Data Input / Output, open drain.   |
| 13   | NC              |   |
| 14   | SMBCLK          | SMBus Serial-Clock Input.   |
| 16   | TH_SHUT         | Thermal Shutdown Output, push-pull output.  |

### **Detailed Description**

The G768D (patents pending) is a 3-in-1 IC. It consists of one temperature sensor, 1 fan speed controller and provides system-reset function.

The temperature sensor is designed to work in conjunction with an external micro-controller ( $\mu$ C) or other intelligence in thermostatic, process-control, or monitoring applications. The  $\mu$ C is typically a powermanagement or keyboard controller, generating SMBus serial commands by "bit-banging" general-purpose input-output (GPIO) pins or via a dedicated SMBus interface block.

Essentially a 12-bit serial analog-to-digital converter (ADC) with a sophisticated front end, the G768D contains a switched current source, a multiplexer, an ADC, an SMBus interface, one fan controller, a reset circuit and associated control logic (Figure 1).

Temperature data from the ADC is loaded into two data registers, where it is automatically compared with data previously stored in four over/under-temperature alarm registers.

#### **ADC** and Multiplexer

The ADC is an averaging type that integrates over a 60ms period (each channel, typical).

The multiplexer automatically steers bias currents through two remote diodes, measures their forward voltages, and computes their temperatures. All channels are converted automatically once the conversion process has started, either in free-running or single-shot mode. If one of the two channels is not used, the device still performs all measurements, and the user can simply ignore the results of the unused channel. If the remote diode channel is unused, tie DXPx to DXN rather than leaving the pins open.

The DXN input is internally connected to the ground node inside the chip to set up the analog to digital (A/D) inputs for a differential measurement. The worst-case DXP-DXN differential input voltage range is 0.25V to 0.95V.

Excess resistance in series with the remote diode causes about +1/2°C error per ohm. Likewise,  $200\mu V$  of offset voltage forced on DXP-DXN causes about 1°C error.

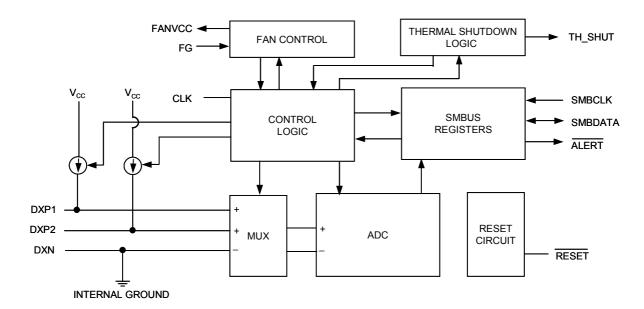


Fig 1. Functional Diagram

#### A/D Conversion Sequence

If a Start command is written (or generated automatically in the free-running auto-convert mode), both two channels are converted, and the results of both measurements are available after the end of conversion. A BUSY status bit in the status byte shows that the device is actually performing a new conversion; however, even if the ADC is busy, the results of the previous conversion are always available.

#### **Remote-Diode Selection**

Temperature accuracy depends on having a good-quality, diode-connected small-signal transistor. Accuracy has been experimentally verified for all of the devices listed in Table 1. The G768D can also directly measure the die temperature of CPUs and other integrated circuits having on-board temperature-sensing diodes. The transistor must be a small-signal type with a relatively high forward voltage; otherwise, the A/D input voltage range can be violated. The forward voltage must be greater than 0.25V at 10µA; check to ensure this is true at the highest expected temperature. The forward voltage must be less than 0.95V at 200A; check to ensure this is true at the lowest expected temperature. Large power transistors don't work at all. Also, ensure that the base resistance is less than  $100\Omega$ . Tight specifications for forward current gain (+50 to +150, for example) indicate that the manufacturer has good process controls and that the devices have consistent VBE characteristics.

#### **Thermal Mass and Self-Heating**

Thermal mass can seriously degrade the G768D's effective accuracy. The thermal time constant of the SSOP-16 package is about 140sec in still air. For the G768D junction temperature to settle to within +1°C after a sudden +100°C change requires about five time constants or 12 minutes. The use of smaller packages for remote sensors, such as SOT23s, improves the situation. Take care to account for thermal gradients between the heat source and the sensor ,and ensure that stray air current across the sensor package do not interfere with measurement accuracy.

**Table 1. Remote-Sensor Transistor Manufacturers** 

| MANUFACTURER                 | MODEL NUMBER |
|------------------------------|--------------|
| Philips                      | PMBS 3904    |
| Motorola (USA)               | MMBT3904     |
| National Semiconductor (USA) | MMBT3904     |

Note:Transistors must be diode-connected (base short -ed to collector).

**G768D** 

#### **ADC Noise Filtering**

The ADC is an integrating type with inherently good noise rejection, especially of low-frequency signals such as 60Hz/120Hz power-supply hum. Micro-power operation places constraints on high-frequency noise rejection; therefore, careful PC board layout and proper external noise filtering are required for high-accuracy remote measurements in electrically noisy environments.

High-frequency EMI is best filtered at DXP and DXN with an external 2200pF capacitor. This value can be increased to about 3300pF(max), including cable capacitance. Higher capacitance than 3300pF introduces errors due to the rise time of the switched current source.

Nearly all noise sources tested cause the ADC measurements to be higher than the actual temperature, typically by +1°C to 10°C, depending on the frequency and amplitude (see Typical Operating Characteristics).

#### **PC Board Layout**

Place the G768D as close as practical to the remote diode. In a noisy environment, such as a computer motherboard, this distance can be 4 in. to 8 in. (typical) or more as long as the worst noise sources (such as CRTs, clock generators, memory buses, and ISA/PCI buses) are avoided.

Do not route the DXP-DXN lines next to the deflection coils of a CRT. Also, do not route the traces across a fast memory bus, which can easily introduce +30°C error, even with good filtering, Otherwise, most noise sources are fairly benign.

Route the DXP and DXN traces in parallel and in close proximity to each other, away from any high-voltage traces such as +12VDC. Leakage currents from PC board contamination must be dealt with carefully, since a  $20 M\Omega$  leakage path from DXP to ground causes about +1°C error.

Route the 2 pairs of DXP1-DXN and DXP2-DXN traces independently (Figure 2a). Connect the common DXN as close as possible to the DXN pin on IC (Figure 2a).

Connect guard traces to GND on either side of the DXP-DXN traces (Figure 2b). With guard traces in place, routing near high-voltage traces is no longer an issue.

Route through as few vias and crossunders as possible to minimize copper/solder thermocouple effects.

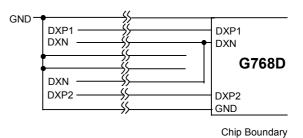
When introducing a thermocouple, make sure that both the DXP and the DXN paths have matching thermocouples. In general, PC board- induced thermocouples are not a serious problem, A copper-solder thermocouple exhibits  $3\mu V/^{\circ}C,$  and it takes about  $200\mu V$  of voltage error at DXP-DXN to cause a +1°C measurement error. So, most parasitic thermocouple errors are swamped out.

Use wide traces. Narrow ones are more inductive and tend to pick up radiated noise. The 10 mil widths and spacing recommended on Figure 2 aren't absolutely necessary (as they offer only a minor improvement in leakage and noise), but try to use them where practical.

Keep in mind that copper can't be used as an EMI shield, and only ferrous materials such as steelwork will. Placing a copper ground plane between the DXP-DXN traces and traces carrying high-frequency noise signals do not help reduce EMI.

#### **PC Board Layout Checklist**

- Place the G768D close to a remote diode.
- Keep traces away from high voltages (+12V bus).
- Keep traces away from fast data buses and CRTs.
- Use recommended trace widths and spacing.
- Place a ground plane under the traces
- Use guard traces flanking DXP and DXN and connecting to GND.
- Route two DXPx-DXN pairs independently
- Connect the common DXN as close as possible to the DXN pin on IC.
- Place the noise filter and the 0.1µF V<sub>CC</sub> bypass capacitors close to the G768D.



■ Fig 2(a) Connect the common DXN as close as possible to the DXN pin on IC.

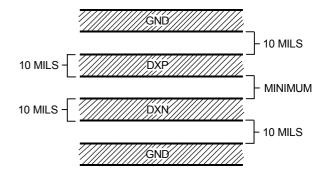


Fig 2 (b) Recommended DXP/DXN PC



**G768D** 

#### **Twisted Pair and Shielded Cables**

For remote-sensor distances longer than 8 in., or in particularly noisy environments, a twisted pair is recommended. Its practical length is 6 feet to 12feet (typical) before noise becomes a problem, as tested in a noisy electronics laboratory. For longer distances, the best solution is a shielded twisted pair like that used for audio microphones. Connect the twisted pair to DXP and DXN and the shield to GND, and leave the shield's remote end unterminated.

Excess capacitance at DX\_limits practical remote sensor distances (see Typical Operating Characteristics), For very long cable runs, the cable's parasitic capacitance often provides noise filtering, so the 2200pF capacitor can often be removed or reduced in value. Cable resistance also affects remote-sensor accuracy;  $1\Omega$  series resistance introduces about + 1°C error

#### **Low-Power Standby Mode**

Standby mode disables the ADC and reduces the supply-current drain to less than  $10\mu A$ . Enter standby mode via the RUN/STOP bit in the configuration byte register. In standby mode, all data is retained in memory, and the SMB interface is alive and listening for reads and writes. This is valid for temperature sensor only.

Standby mode is not a shutdown mode. With activity on the SMBus, extra supply current is drawn (see Typical Operating Characteristics). In software standby mode, the G768D can be forced to perform temperature measurement via the one-shot command, despite the RUN/STOP bit being high.

Supply-current drain during the 125ms conversion period is always about  $500\mu A$ . Slowing down the conversion rate reduces the average supply current (see Typical Operating Characteristics). In between conversions, the instantaneous supply current is about  $200\mu A$  due to the current consumed by the system resetting circuit.

#### **Fan Controller**

Since the fan speed is measured by counting the number of 32.768KHz cycles between the rising edges of two fan speed pulses. In this way, we are actually measuring the period of the fan speed. To avoid the cost of doing division to obtain the speed, this count number, N, is used in the PWM control algorithm, thus, the desired fan speed should be programmed by writing the corresponding count number. The count number is given by:

#### N: Count Number

P: FG pulses number per revolution

 $P=1 \Rightarrow N = 983040 / rpm$ 

 $P=2 \Rightarrow N = 491520 / rpm$ 

 $P=4 \Rightarrow N = 245762 / rpm$ 

Some selected count number for P=2 are listed below.

Table 2.

| Rpm   | N   |
|-------|-----|
| 3000  | 164 |
| 4000  | 123 |
| 5000  | 98  |
| 6000  | 82  |
| 7000  | 70  |
| 8000  | 61  |
| 9000  | 55  |
| 10000 | 49  |
| 20000 | 25  |
| 30000 | 16  |

To stop the fan, program the fan speed register to 255. This also makes the fan controller enter power saving mode.

#### **Controlling Fan at Lower Speed**

For stably controlling fans at lower rotation speed, three schemes are recommended as below:

- Use larger decoupling capacitors between FANVCC and GND.
- 2. Shunt a capacitor of  $1\mu$ F- $2\mu$ F on FG pin to GND.
- 3.Use fans with open-collector FG outputs.

When controlling fans under lower rotation speed, the output voltage of FANVCC would be too low for fan to generate recognizable FG signals.

Using decouple capacitors on FANVCC and FG is to increase the SNR on FG pins. While using fans with open-collector FG outputs can thoroughly solve the problem, because the logic high level of FG would be fixed to 5V.

#### Reset Immunity Negative-Going V<sub>CC</sub> Transients

In addition to issuing a reset to the microprocessor ( $\mu P$ ) during power-up, power-down, and brownout conditions, the G768D is relatively immune to short duration negative-going  $V_{CC}$  transients (glitches).

Typically, for the G768D, a  $V_{\text{CC}}$  transient that goes 100mV below the reset threshold and lasts 20 $\mu$ s or less will not cause a reset pulse. A 0.1 $\mu$ F bypass capacitor mounted as close as possible to the  $V_{\text{CC}}$  pin provides additional transient immunity.

### Ensuring a Valid Reset Output Down to V<sub>cc</sub> = 0V

When  $V_{\text{CC}}$  falls below 1V, the G768D RESET output no longer sinks current-it becomes an open circuit. Therefore, high-impedance CMOS logic inputs connected to RESET can drift to undetermined voltages. This presents no problem in most applications, since most  $\mu P$  and other circuitry is inoperative with  $V_{\text{CC}}$  below 1V. However, in applications where RESET must be valid down to 0V, adding a pull-down resistor to RESET causes any stray leakage currents to flow to ground, holding RESET low (Figure 3). R1's value is not critical;  $100 \text{k}\Omega$  is large enough not to load RESET and small enough to pull RESET to ground.

#### Interfacing to µPs with Bi-directional Reset Pins

A  $\mu P$  with bi-directional reset pins (such as the Motorola 68HC11 series) can connect to the G768D reset output. If, for example, the G768D  $\overline{\text{RESET}}$  output is asserted high and the  $\mu P$  wants to pull it low, indeterminate logic levels may result. To correct this, connect a 4.7k $\Omega$  resistor between the G768D  $\overline{\text{RESET}}$  output and the  $\mu P$  reset I/O (Figure 4). Buffer the G768D  $\overline{\text{RESET}}$  output to other system components.

#### **SMBus Digital Interface**

From a software perspective, the G768D appears as a set of byte-wide registers that contain temperature data, alarm threshold values, fan speed data, or control bits, A standard SMBus 2-wire serial interface is used to read temperature data and write control bits and alarm threshold data. Each A/D and fan control channel within the device responds to the same SMBus slave address for normal reads and writes.

The G768D employs four standard SMBus protocols: Write Byte, Read Byte, Send Byte, and Receive Byte (Figure 5). The shorter Receive Byte protocol allows quicker transfers, provided that the correct data register was previously selected by a Read Byte instruction. Use caution with the shorter protocols in multi-master systems, since a second master could over-write the command byte without informing the first master.

The temperature data format is 7bits plus sign in twos-complement form for each channel, with each data bit representing 1°C (Table3), transmitted MSB first. Measurements are offset by +1/2°C to minimize internal rounding errors; for example, +99.6°C is reported as +100°C.

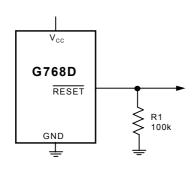


Fig 3 RESET Valid to  $V_{cc}$  = Ground Circuit

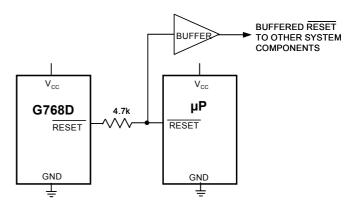


Fig 4. Interfacing to µPs with Bi-directional Reset I/O



| Write Byte Format |         |    |     |         |     |        |     |   |  |  |
|-------------------|---------|----|-----|---------|-----|--------|-----|---|--|--|
| S                 | Address | WR | ACK | Command | ACK | DATA   | ACK | Р |  |  |
|                   | 7 hits  |    |     | 8 hits  |     | 8 hits |     | 1 |  |  |

**Slave Address:** equivalent to chip-select line of a 3-wire interface **Command Byte:** selects, which register you, are writing to

Data Byte: data goes into the register set by the command byte (to set thresholds, configuration masks, and

sampling rate)

#### **Read Byte Format**

| S | Address | WR | ACK | Command | ACK | S | Address | RD | ACK | DATA   |  | Р |
|---|---------|----|-----|---------|-----|---|---------|----|-----|--------|--|---|
|   | 7 bits  |    |     | 8 bits  |     |   | 7 bits  |    |     | 8 bits |  |   |

Slave Address: equivalent to chip- select line

**Command Byte:** selects, which register you, are reading from **Slave Address:** repeated due to change in data-flow direction **Data byte:** reads from the register set by the command byte

#### **Send Byte Format**

| S | Address | WR | ACK | Command | ACK | Р |
|---|---------|----|-----|---------|-----|---|
|   | 7 bits  |    |     | 8 bits  |     |   |

Command Byte: sends command with no data usually used for one-shot command

#### **Receive Byte Format**

| S | Address | RD | ACK | Data   | III | Р |
|---|---------|----|-----|--------|-----|---|
|   | 7 bits  |    |     | 8 bits |     |   |

**Data Byte:** reads data from the register commanded by the last Read Byte or Write Byte transmission; also used for SMBus Alert Response return address

S = Start condition Shaded = Slave transmission P = Stop condition /// = Not acknowledged

Fig 5. SMBus Protocols

**Table 3. Data Format (Twos-Complement)** 

| TEMP.   | ROUND | DIGIT     | AL OUTP | UT   |  |  |
|---------|-------|-----------|---------|------|--|--|
| (°C)    | TEMP. | DATA BITS |         |      |  |  |
| ( 0)    | (°C)  | SIGN      | MSB     | LSB  |  |  |
| +130.00 | +127  | 0         | 111     | 1111 |  |  |
| +127.00 | +127  | 0         | 111     | 1111 |  |  |
| +126.50 | +127  | 0         | 111     | 1111 |  |  |
| +126.00 | +126  | 0         | 111     | 1110 |  |  |
| +25.25  | +25   | 0         | 001     | 1001 |  |  |
| +0.50   | +1    | 0         | 000     | 0001 |  |  |
| +0.25   | +0    | 0         | 000     | 0000 |  |  |
| +0.00   | +0    | 0         | 000     | 0000 |  |  |
| -0.25   | +0    | 0         | 000     | 0000 |  |  |
| -0.50   | +0    | 0         | 000     | 0000 |  |  |
| -0.75   | -1    | 1         | 111     | 1111 |  |  |
| -1.00   | -1    | 1         | 111     | 1111 |  |  |
| -25.00  | -25   | 1         | 110     | 0111 |  |  |
| -25.50  | -25   | 1         | 110     | 0110 |  |  |
| -54.75  | -55   | 1         | 100     | 1001 |  |  |
| -55.00  | -55   | 1         | 100     | 1001 |  |  |
| -65.00  | -65   | 1         | 011     | 1111 |  |  |
| -70.00  | -65   | 1         | 011     | 1111 |  |  |

#### **Alarm Threshold Registers**

Four registers store alarm threshold data, with high-temperature (THIGH) and low-temperature (TLOW) registers for each A/D channel. If either measured temperature equals or exceeds the corresponding alarm threshold value, an ALERT interrupt is asserted.

The power-on-reset (POR) state of both THIGH registers is full scale (0111 1111, or +127°C). The POR state of both TLOW registers is 1100 1001 or -55°C.

#### **Diode Fault Alarm**

There is a continuity fault detector at DXP that detects whether the remote diode has an open-circuit condition. At the beginning of each conversion, the diode fault is checked, and the status byte is updated. This fault detector is a simple voltage detector; if DXP rises above  $V_{\text{CC}}\text{-1V}$  (typical) due to the diode current source, a fault is detected. Note that the diode fault isn't checked until a conversion is initiated, so immediately after power-on reset the status byte indicates no fault is present, even if the diode path is broken.



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If the remote channel is shorted (DXP to DXN or DXP to GND), the ADC reads 0000 0000 so as not to trip either the THIGH or TLOW alarms at their POR settings. In applications that are never subjected to 0°C in normal operation, a 0000 0000 result can be checked to indicate a fault condition in which DXP is accidentally short circuited. Similarly, if DXP is short circuited to  $V_{\rm CC}$ , the ADC reads +127°C for both channels, and the device alarms.

#### **ALERT** Interrupts

The ALERT interrupt output signal is latched and can only be cleared by reading the Alert Response address. Interrupts are generated in response to THIGH and TLOW comparisons and when the remote diode is disconnected (for continuity fault detection). The interrupt does not halt automatic conversions; new temperature data continues to be available over the SMBus interface after ALERT is asserted. The interrupt output

rupt output pin is open-drain so that device can share a common interrupt line. The interrupt rate can never exceed the conversion rate.

The interface responds to the SMBus Alert Response address, an interrupt pointer return-address feature (see Alert Response Address section). Prior to taking corrective action, always check to ensure that an interrupt is valid by reading the current temperature.

#### **Alert Response Address**

The SMBus Alert Response interrupt pointer provides quick fault identification for simple slave devices that lack the complex, expensive logic needed to be a bus master. Upon receiving an ALERT interrupt signal, the host master can broadcast a Receive Byte transmission to the Alert Response slave address (0001 100). Then any slave device that generated an interrupt attempts to identify itself by putting its own address on the bus.

Table 4. Command-Byte Bit Assignments

| REGISTER | COMMAND | POR STATE        | FUNCTION  |  |
|----------|---------|------------------|---|--|
| RRTE2    | 00h     | 0000 0000b       | Read 2nd remote temperature: returns latest temperature           |  |
| RRTE1    | 01h     | 0000 0000b       | Read 1st remote temperature: returns latest temperature           |  |
| RSL      | 02h     | N/A              | Read status byte (flags, busy signal)                             |  |
| RCL      | 03h     | 0000 0000b       | Read configuration byte   |  |
| RCRA     | 04h     | 0000 0010b       | Read conversion rate byte   |  |
| RRHI2    | 05h     | 0111 1111b (127) | Read 2nd remote THIGH limit                                       |  |
| RRLS2    | 06h     | 1100 1001b(-55)  | Read 2nd remote TLOW limit  |  |
| RRHI1    | 07h     | 0111 1111b (127) | Read 1st remote THIGH limit                                       |  |
| RRLS1    | 08h     | 1100 1001b (-55) | Read 1st remote TLOW limit  |  |
| WCA      | 09h     | N/A              | Write configuration byte  |  |
| WCRW     | 0Ah     | N/A              | Write conversion rate byte  |  |
| WRHA2    | 0Bh     | N/A              | Write 2nd remote THIGH limit                                      |  |
| WRLN2    | 0Ch     | N/A              | Write 2nd remote TLOW limit                                       |  |
| WRHA1    | 0Dh     | N/A              | Write 1st remote THIGH limit                                      |  |
| WRLN1    | 0Eh     | N/A              | Write 1st remote TLOW limit                                       |  |
| OSHT     | 0Fh     | N/A              | One-shot command (use send-byte format)                           |  |
| SET_CNT1 | 10h     | 1111 1111b       | Write 1st fan programmed speed register                           |  |
| ACT_CNT1 | 11h     | 1111 1111b       | Read 1st fan actual speed register                                |  |
| FAN_STA1 | 12h     | 10b              | Read 1st fan status register                                      |  |
| TMAX1    | 31h     | 0100 0110b (70)  | 1st remote TMAX   |  |
| THYST1   | 32h     | 0011 1100b (60)  | 1st remote THYST  |  |
| TMAX2    | 33h     | 0100 0110b (70)  | 2nd remote TMAX   |  |
| THYST2   | 34h     | 0011 1100b (60)  | 2nd remote THYST  |  |
| TCRIT1   | 35h     | 0110 1100b (108) | Critical temperature for 1 <sup>st</sup> remote temperaure sensor |  |
| TCRIT2   | 36h     | 0101 1000b (88)  | Critical temperature for 2 <sup>nd</sup> remote temperaure sensor |  |



**G768D** 

The Alert Response can activate several different slave devices simultaneously, similar to the SMBus General Call. If more than one slave attempts to respond, bus arbitration rules apply, and the device with the lower address code wins. The losing device does not generate an acknowledge and continues to hold the  $\overline{\text{ALERT}}$  line low until serviced (implies that the host interrupt input is level sensitive). Successful reading of the alert response address clears the interrupt latch.

#### **Command Byte Functions**

The 8-bit command byte register (Table 4) is the master index that points to the various other registers within the G768D. The register's POR state is 0000 0000, so that a Receive Byte transmission (a protocol that lacks the command byte) that occurs immediately after POR returns the current local temperature data. The one-shot command immediately forces a new conversion cycle to begin. In software standby mode ( $\overline{\text{RUN}}/\text{STOP}$  bit = high), a new conversion is begun, after which the device returns to standby mode. If a conversion is in progress when a one-shot command is received in auto-convert mode ( $\overline{\text{RUN}}/\text{STOP}$  bit = low) between conversions, a new conversion begins, the conversion rate timer is reset, and the next automatic conversion takes place after a full delay elapses.

#### **Configuration Byte Functions**

The configuration byte register contents are listed in table 5. Bit 7(MASK) is used to mask ALERT interrupt.

Bit 6 (RUN/STOP) is to put the device in software standby mode. Setting bit 5 (DET\_FAN) with logic 1 can activate the detection of fan failure. Logic 1 in bit 4 (EN\_TH\_SHUT) makes thermal shutdown function valid and logic 0 disables this function and keep TH\_SHUT pin low. Bit 3~0 forms thermal shutdown fault queue. The number of faults these bits decided are listed in table 6.

#### **Thermal Status Byte Functions**

The thermal status byte register (02h) (Table 6) indicates which (if any) temperature thresholds have been exceeded. This byte also indicates whether or not the ADC is converting and whether there is an open circuit in the remote diode DXPx-DXN path. After POR, the normal state of all the flag bits is zero, assuming none of the alarm conditions are present. The status byte is cleared by any successful read of the status, unless the fault persists. Note that the ALERT interrupt latch is not automatically cleared when the status flag bit is cleared.

When reading the status byte, you must check for internal bus collisions caused by asynchronous ADC timing, or else disable the ADC prior to reading the status byte (via the RUN/STOP bit in the configuration byte). In one-shot mode, read the status byte only after the conversion is complete, which is 150ms max after the one-shot conversion is commanded.

Table 5. Configuration-Byte Bit Assignments

| BIT     | NAME       | POR STATE  | FUNCTION  |
|---------|------------|------------|---|
| 7 (MSB) | MASK       | 0          | Masks all ALERT interrupts when high.   |
| 6       | RUN / STOP | l ()       | Standby mode control bit. If high, the device immediately stops converting and enters standby mode. If low, the device converts in either one-shot or timer mode. |
| 5       | DET_FAN    | 0          | Validation of the fan failure detection. If high, activated. If low, disable.   |
| 4       | EN_TH_SHUT | 1          | Validation of the fault queue function of thermal shutdown.   |
| 3-0     | FQ_TH_SHUT | I ()()1()h | Fault Queue. Number of faults necessary to detect before setting TH_SHUT output to avoid false tripping due to noise.   |

Table 6. Number of Faults assigned by FQ TH SHUT

| FQ_TH_SHUT | Number of Faults    |
|------------|---------------------|
| 0000b      | 1                   |
| 0001b      | 2                   |
| 0010b      | 3(Power-up default) |
| 0011b      | 4                   |
| 0100b      | 5                   |
| 0101b      | 6                   |
| 0110b      | 7                   |
| 0111b      | 8                   |

| FQ_TH_SHUT | Number of Faults |
|------------|------------------|
| 1000b      | 9                |
| 1001b      | 10               |
| 1010b      | 11               |
| 1011b      | 12               |
| 1100b      | 13               |
| 1101b      | 14               |
| 1110b      | 15               |
| 1111b      | 16               |

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Table 7. Status-Byte Bit Assignments

| BIT    | NAME      | FUNCTION  |  |
|--------|-----------|---|--|
| 7(MSB) | BUSY      | A high indicates that the ADC is busy converting.                                     |  |
| 6      | RHIGH2*   | A high indicates that the 2 <sup>nd</sup> diode high-temperature alarm has activated. |  |
| 5      | RLOW2*    | A high indicates that the 2 <sup>nd</sup> diode low-temperature alarm has activated.  |  |
| 4      | RHIGH1*   | high indicates that the 1 <sup>st</sup> diode high-temperature alarm has activated.   |  |
| 3      | RLOW1*    | high indicates that the 1 <sup>st</sup> diode low-temperature alarm has activated.    |  |
| 2      | OPEN*     | A high indicates a remote-diode continuity (open-circuit) fault.                      |  |
| 1      | RFU       | Reserved for future use (returns 0)   |  |
| 0(LSB) | FAN_FAIL* | A high indicates that the fan failure alarm has activated.                            |  |

<sup>\*</sup>These flags stay high until cleared by POR, or until the status byte register is read.

**Table 8. Conversion-Rate Control Byte** 

| DATA       | CONVERSION<br>RATE (Hz) | Temperature Sensor Average<br>Supply Current (µA TYP, at V <sub>cc</sub> = 5V) |
|------------|-------------------------|--|
| 00h        | 0.0625                  | 30   |
| 01h        | 0.125                   | 33   |
| 02h        | 0.25                    | 35   |
| 03h        | 0.5                     | 48   |
| 04h        | 1                       | 70   |
| 05h        | 2                       | 128  |
| 06h        | 4                       | 225  |
| 07h        | 8                       | 425  |
| 08h to FFh | RFU                     | -  |

Table 9. RLTS and RRTE Temp Register Update Timing Chart

| OPERATING MODE   | CONVERSION<br>INITIATED BY:                                | NEW CONVERSION RATE<br>(CHANGED VIA WRITE TO CRW) | TIME UNTIL RLTS AND<br>RRTE ARE UPDATED                 |
|------------------|--|---|---|
| Auto-Convert     | Power-on reset   | N/A (0.25Hz)                                      | 156ms max   |
| Auto-Convert     | 1-shot command, while idling between automatic conversions | N/A   | 156ms max   |
| Auto-Convert     | 1-shot command that occurs during a conversion             | N/A   | When current conversion is complete (1-shot is ignored) |
| Auto-Convert     | Rate timer   | 0.0625Hz  | 20sec   |
| Auto-Convert     | Rate timer   | 0.125Hz   | 10sec   |
| Auto-Convert     | Rate timer   | 0.25Hz  | 5sec  |
| Auto-Convert     | Rate timer   | 0.5Hz   | 2.5sec  |
| Auto-Convert     | Rate timer   | 1Hz   | 1.25sec   |
| Auto-Convert     | Rate timer   | 2Hz   | 625ms   |
| Auto-Convert     | Rate timer   | 4Hz   | 312.5ms   |
| Auto-Convert     | Rate timer   | 8Hz   | 237.5ms   |
| Software Standby | RUN/STOP bit   | N/A   | 156ms   |
| Software Standby | 1-shot command   | N/A   | 156ms   |



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To check for internal bus collisions, read the status byte. If the least significant seven bits are ones, discard the data and read the status byte again. The status bits LHIGH, LLOW, RHIGH, and RLOW are refreshed on the SMBus clock edge immediately following the stop condition, so there is no danger of losing temperature-related status data as a result of an internal bus collision. The OPEN status bit (diode continuity fault) is only refreshed at the beginning of a conversion, so OPEN data is lost. The ALERT interrupt latch is independent of the status byte register, so no false alerts are generated by an internal bus collision.

When auto-converting, if the THIGH and TLOW limits are close together, it's possible for both high-temp and low-temp status bits to be set, depending on the amount of time between status read operations (especially when converting at the fastest rate). In these circumstances, it's best not to rely on the status bits to indicate reversals in long-term temperature changes and instead use a current temperature reading to establish the trend direction.

#### **Temperature Conversion Rate Byte**

The conversion rate register (Table 7) programs the time interval between conversions in free running auto-convert mode. This variable rate control reduces the supply current in portable-equipment applications. The conversion rate byte's POR state is 02h (0.25Hz). The G768D looks only at the 3 LSB bits of this register, so the upper 5 bits are "don't care" bits, which should be set to zero. The conversion rate tolerance is  $\pm 25\%$  at any rate setting.

Valid A/D conversion results for all channels are available one total conversion time (125ms nominal, 156ms maximum) after initiating a conversion, whether conversion is initiated via the RUN/STOP bit, one-shot command, or initial power-up. Changing the conversion rate can also affect the delay until new results are available. See Table 8.

#### Programmed fan speed register

The programmed fan speed register 10h is read / write register. They contain the count number of the desired fan speed. Power up default is FFh.

#### Actual fan speed register

The actual fan speed register 11h is read only. They contain the count number of the actual fan speed. Power up default is FFh.

#### Fan status register

The fan status registers 12h is read only. Its bit 0 is set to 1 when the actual fan speed is  $\pm 20\%$  outside the desired speed. Its bit 1 is set to 1 when fan speed is below 1920 rpm. Power up default is 0000 0010b.

#### Watchdog for fan control

Four temperature threshold registers intervene the control of fan. Pin FANVCC go high when one of the remote temperature, DX1 and DX2, rises above the respective TMAX. The control is not released until both temperature values drop below their THYST Besides, the fan controller also fully turns on the fan when either of the two remote diodes is open or both are short.

The power-up default values for TMAX and THYST are +70°C and +60°C, respectively. This allows the G768D to be used in the occasion when system fails and loses the fan control of G768D.

#### **Slave Addresses**

The G768D appears to the SMBus as one device having a common address for all the ADC and fan control channels. The device address is fixed to be 7Ah for write and 7Bh for read.

The G768D also responds to the SMBus Alert Response slave address (see the Alert Response Address section).

#### **POR and UVLO**

The G768D has a volatile memory. To prevent ambiguous power-supply conditions from corrupting the data in memory and causing erratic behavior, a POR voltage detector monitors  $V_{\rm CC}$  and clears the memory if  $V_{\rm CC}$  falls below 1.7V (typical, see Electrical Characteristics table). When power is first applied and  $V_{\rm CC}$  rises above 1.75V (typical), the logic blocks begin operating, although reads and writes at  $V_{\rm CC}$  levels below 3V are not recommended. A second  $V_{\rm CC}$  comparator, the ADC UVLO comparator, prevents the ADC from converting until there is sufficient headroom ( $V_{\rm CC}$  = 2.8V typical).

#### **Power-Up Defaults:**

- Interrupt latch is cleared.
- ADC begins auto /converting at a 0.25Hz rate.
- Command byte is set to 00h to facilitate quick remote Receive Byte queries.
- THIGH and TLOW registers are set to max and min limits, respectively

#### **Detection On fan Failure**

Setting bit 5 (DET\_FAN) of CONFIGURATION-BYTE register with logic 1 activates the detection of fan failure. G768D detects fan failure via FG pin. G768D defines fan failure as no transition on FG pin for about 0.5sec or the fan measurement result is 255 counts for consecutive 8 times, it takes about 0.25sec. Once fan failure is detected the ALERT# will be set to logic low and the bit 0 (FAN\_FAIL) of STATUS-BYTE will be set to logic high.

To clear the ALERT# signal caused by fan failure, the DET\_FAN bit should be set to 0 then issue an ARA command on serial bus.

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**G768D** 

#### **Thermal Shutdown Signal**

When the temperature of DX1 reaches or exceeds the Tcrit1 threshold consecutively for the times equal to the number of faults of the FQ\_TH\_SHUT registers, TH\_SHUT pin becomes logic high. The

same mechanism is duplicated for DX2. There fore, either one of DX1, DX2 continuously over their respective Tcrit, the TH\_SHUT will assert logic high to indicate a thermal shutdown event.

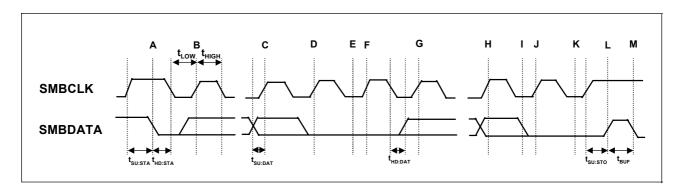


Figure 6. SMBus Write Timing Diagram

A = start condition

B = MSB of address clocked into slave

C = LSB of address clocked into slave

D = R / W bit clocked into slave

E = slave pulls SMB Data line low

F = acknowledge bit clocked into master

G = MSB of data clocked into slave

H = LSB of data clocked into slave

I = slave pulls SMBDATA line low

J = acknowledge clocked into master

K = acknowledge clocked pulse

L = stop condition data executed by slave

M = new start condition

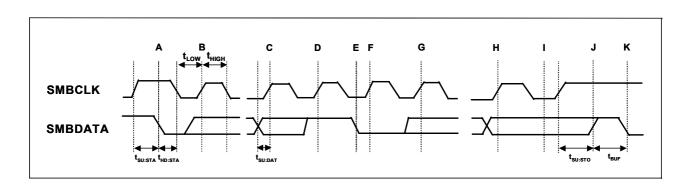


Figure 7. SMBus Read Timing Diagram

A = start condition

B = MSB of address clocked into slave

C = LSB of address clocked into slave

 $D = R / \overline{W}$  bit clocked into slave

E = slave pulls SMBDATA line low

F =acknowledge bit clocked into master

G = MSB of data clocked into master

H = LSB of data clocked into master

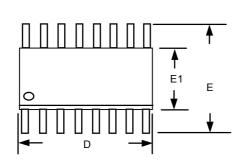
I = acknowledge clocked pulse

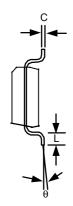
J = stop condition

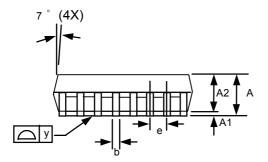
K= new start condition



# Package Information





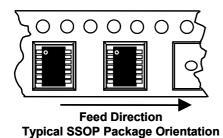


#### Note:

- 1. Package body sizes exclude mold flash and gate burrs
- 2. Dimension L is measured in gage plane
- 3. Tolerance 0.10mm unless other wise specified
- 4. Controlling dimension is millimeter converted inch dimensions are not necessarily exact.

| SYMBOLS  | DIMENSION IN MM |      |      | DIMENSION IN INCH |       |       |  |
|----------|-----------------|------|------|-------------------|-------|-------|--|
|          | MIN             | NOM  | MAX  | MIN               | NOM   | MAX   |  |
| А        | 1.35            | 1.60 | 1.75 | 0.053             | 0.064 | 0.069 |  |
| A1       | 0.10            |      | 0.25 | 0.004             |       | 0.010 |  |
| A2       |                 | 1.45 |      |                   | 0.057 |       |  |
| b        | 0.20            | 0.25 | 0.30 | 0.008             | 0.010 | 0.012 |  |
| С        | 0.19            |      | 0.25 | 0.007             |       | 0.010 |  |
| D        | 4.80            |      | 5.00 | 0.189             |       | 0.197 |  |
| E        | 5.80            |      | 6.20 | 0.228             |       | 0.244 |  |
| E1       | 3.80            |      | 4.00 | 0.150             |       | 0.157 |  |
| е        |                 | 0.64 |      |                   | 0.025 |       |  |
| L        | 0.40            |      | 1.27 | 0.016             |       | 0.050 |  |
| у        |                 |      | 0.10 |                   |       | 0.004 |  |
| $\theta$ | 0°              |      | 8°   | 0°                |       | 8°    |  |

## **Taping Specification**



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